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Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	8MHz
Connectivity	UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	33
Program Memory Size	4KB (2K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	232 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-QFP
Supplier Device Package	44-MQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17lc42a-08i-pq

1.0 OVERVIEW

This data sheet covers the PIC17C4X group of the PIC17CXX family of microcontrollers. The following devices are discussed in this data sheet:

- PIC17C42
- PIC17CR42
- PIC17C42A
- PIC17C43
- PIC17CR43
- PIC17C44

The PIC17CR42, PIC17C42A, PIC17C43, PIC17CR43, and PIC17C44 devices include architectural enhancements over the PIC17C42. These enhancements will be discussed throughout this data sheet.

The PIC17C4X devices are 40/44-Pin, EPROM/ROM-based members of the versatile PIC17CXX family of low-cost, high-performance, CMOS, fully-static, 8-bit microcontrollers.

All PIC16/17 microcontrollers employ an advanced RISC architecture. The PIC17CXX has enhanced core features, 16-level deep stack, and multiple internal and external interrupt sources. The separate instruction and data buses of the Harvard architecture allow a 16-bit wide instruction word with a separate 8-bit wide data. The two stage instruction pipeline allows all instructions to execute in a single cycle, except for program branches (which require two cycles). A total of 55 instructions (reduced instruction set) are available in the PIC17C42 and 58 instructions in all the other devices. Additionally, a large register set gives some of the architectural innovations used to achieve a very high performance. For mathematical intensive applications all devices, except the PIC17C42, have a single cycle 8 x 8 Hardware Multiplier.

PIC17CXX microcontrollers typically achieve a 2:1 code compression and a 4:1 speed improvement over other 8-bit microcontrollers in their class.

PIC17C4X devices have up to 454 bytes of RAM and 33 I/O pins. In addition, the PIC17C4X adds several peripheral features useful in many high performance applications including:

- Four timer/counters
- Two capture inputs
- Two PWM outputs
- A Universal Synchronous Asynchronous Receiver Transmitter (USART)

These special features reduce external components, thus reducing cost, enhancing system reliability and reducing power consumption. There are four oscillator options, of which the single pin RC oscillator provides a low-cost solution, the LF oscillator is for low frequency crystals and minimizes power consumption, XT is a standard crystal, and the EC is for external clock input. The SLEEP (power-down) mode offers additional

power saving. The user can wake-up the chip from SLEEP through several external and internal interrupts and device resets.

There are four configuration options for the device operational modes:

- Microprocessor
- Microcontroller
- Extended microcontroller
- Protected microcontroller

The microprocessor and extended microcontroller modes allow up to 64K-words of external program memory.

A highly reliable Watchdog Timer with its own on-chip RC oscillator provides protection against software malfunction.

Table 1-1 lists the features of the PIC17C4X devices.

A UV-erasable Cerdip-packaged version is ideal for code development while the cost-effective One-Time Programmable (OTP) version is suitable for production in any volume.

The PIC17C4X fits perfectly in applications ranging from precise motor control and industrial process control to automotive, instrumentation, and telecom applications. Other applications that require extremely fast execution of complex software programs or the flexibility of programming the software code as one of the last steps of the manufacturing process would also be well suited. The EPROM technology makes customization of application programs (with unique security codes, combinations, model numbers, parameter storage, etc.) fast and convenient. Small footprint package options make the PIC17C4X ideal for applications with space limitations that require high performance. High speed execution, powerful peripheral features, flexible I/O, and low power consumption all at low cost make the PIC17C4X ideal for a wide range of embedded control applications.

1.1 Family and Upward Compatibility

Those users familiar with the PIC16C5X and PIC16CXX families of microcontrollers will see the architectural enhancements that have been implemented. These enhancements allow the device to be more efficient in software and hardware requirements. Please refer to Appendix A for a detailed list of enhancements and modifications. Code written for PIC16C5X or PIC16CXX can be easily ported to PIC17CXX family of devices (Appendix B).

1.2 Development Support

The PIC17CXX family is supported by a full-featured macro assembler, a software simulator, an in-circuit emulator, a universal programmer, a "C" compiler, and fuzzy logic support tools.

FIGURE 3-2: PIC17CR42/42A/43/R43/44 BLOCK DIAGRAM

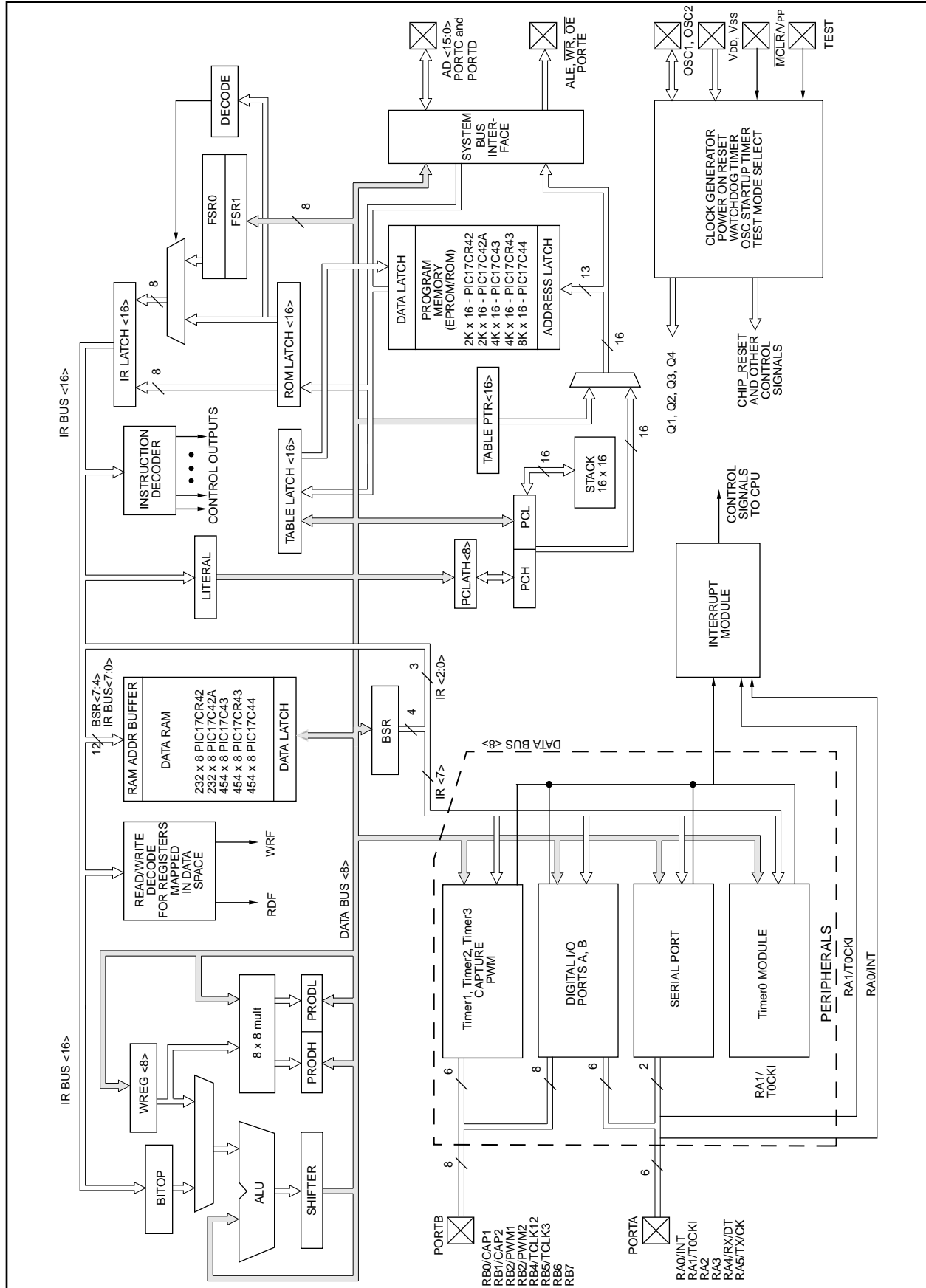


TABLE 4-4: INITIALIZATION CONDITIONS FOR SPECIAL FUNCTION REGISTERS

Register	Address	Power-on Reset	MCLR Reset WDT Reset	Wake-up from SLEEP through interrupt
Unbanked				
INDF0	00h	0000 0000	0000 0000	0000 0000
FSR0	01h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCL	02h	0000h	0000h	PC + 1 ⁽²⁾
PCLATH	03h	0000 0000	0000 0000	uuuu uuuu
ALUSTA	04h	1111 xxxx	1111 uuuu	1111 uuuu
T0STA	05h	0000 000-	0000 000-	0000 000-
CPUSTA ⁽³⁾	06h	--11 11--	--11 qq--	--uu qq--
INTSTA	07h	0000 0000	0000 0000	uuuu uuuu ⁽¹⁾
INDF1	08h	0000 0000	0000 0000	uuuu uuuu
FSR1	09h	xxxx xxxx	uuuu uuuu	uuuu uuuu
WREG	0Ah	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR0L	0Bh	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR0H	0Ch	xxxx xxxx	uuuu uuuu	uuuu uuuu
TBLPTRL ⁽⁴⁾	0Dh	xxxx xxxx	uuuu uuuu	uuuu uuuu
TBLPTRH ⁽⁴⁾	0Eh	xxxx xxxx	uuuu uuuu	uuuu uuuu
TBLPTRL ⁽⁵⁾	0Dh	0000 0000	0000 0000	uuuu uuuu
TBLPTRH ⁽⁵⁾	0Eh	0000 0000	0000 0000	uuuu uuuu
BSR	0Fh	0000 0000	0000 0000	uuuu uuuu
Bank 0				
PORTA	10h	0-xx xxxx	0-uu uuuu	uuuu uuuu
DDRB	11h	1111 1111	1111 1111	uuuu uuuu
PORTB	12h	xxxx xxxx	uuuu uuuu	uuuu uuuu
RCSTA	13h	0000 -00x	0000 -00u	uuuu -uuu
RCREG	14h	xxxx xxxx	uuuu uuuu	uuuu uuuu
TXSTA	15h	0000 --1x	0000 --1u	uuuu --uu
TXREG	16h	xxxx xxxx	uuuu uuuu	uuuu uuuu
SPBRG	17h	xxxx xxxx	uuuu uuuu	uuuu uuuu
Bank 1				
DDRC	10h	1111 1111	1111 1111	uuuu uuuu
PORTC	11h	xxxx xxxx	uuuu uuuu	uuuu uuuu
DDRD	12h	1111 1111	1111 1111	uuuu uuuu
PORTD	13h	xxxx xxxx	uuuu uuuu	uuuu uuuu
DDRE	14h	---- -111	---- -111	---- -uuu
PORTE	15h	---- -xxx	---- -uuu	---- -uuu
PIR	16h	0000 0010	0000 0010	uuuu uuuu ⁽¹⁾
PIE	17h	0000 0000	0000 0000	uuuu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented read as '0', q = value depends on condition.

Note 1: One or more bits in INTSTA, PIR will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GLINTD bit is cleared, the PC is loaded with the interrupt vector.

3: See Table 4-3 for reset value of specific condition.

4: Only applies to the PIC17C42.

5: Does not apply to the PIC17C42.

TABLE 6-3: SPECIAL FUNCTION REGISTERS (Cont'd)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (3)
Bank 2											
10h	TMR1	Timer1								xxxx xxxx	uuuu uuuu
11h	TMR2	Timer2								xxxx xxxx	uuuu uuuu
12h	TMR3L	TMR3 register; low byte								xxxx xxxx	uuuu uuuu
13h	TMR3H	TMR3 register; high byte								xxxx xxxx	uuuu uuuu
14h	PR1	Timer1 period register								xxxx xxxx	uuuu uuuu
15h	PR2	Timer2 period register								xxxx xxxx	uuuu uuuu
16h	PR3L/CA1L	Timer3 period register, low byte/capture1 register; low byte								xxxx xxxx	uuuu uuuu
17h	PR3H/CA1H	Timer3 period register, high byte/capture1 register; high byte								xxxx xxxx	uuuu uuuu
Bank 3											
10h	PW1DCL	DC1	DC0	—	—	—	—	—	—	xx-- ----	uu-- ----
11h	PW2DCL	DC1	DC0	TM2PW2	—	—	—	—	—	xx0- ----	uu0- ----
12h	PW1DCH	DC9	DC8	DC7	DC6	DC5	DC4	DC3	DC2	xxxx xxxx	uuuu uuuu
13h	PW2DCH	DC9	DC8	DC7	DC6	DC5	DC4	DC3	DC2	xxxx xxxx	uuuu uuuu
14h	CA2L	Capture2 low byte								xxxx xxxx	uuuu uuuu
15h	CA2H	Capture2 high byte								xxxx xxxx	uuuu uuuu
16h	TCON1	CA2ED1	CA2ED0	CA1ED1	CA1ED0	T16	TMR3CS	TMR2CS	TMR1CS	0000 0000	0000 0000
17h	TCON2	CA2OVF	CA1OVF	PWM2ON	PWM1ON	CA1/PR3	TMR3ON	TMR2ON	TMR1ON	0000 0000	0000 0000
Unbanked											
18h ⁽⁵⁾	PRODL	Low Byte of 16-bit Product (8 x 8 Hardware Multiply)								xxxx xxxx	uuuu uuuu
19h ⁽⁵⁾	PRODH	High Byte of 16-bit Product (8 x 8 Hardware Multiply)								xxxx xxxx	uuuu uuuu

- Legend: x = unknown, u = unchanged, - = unimplemented read as '0', q - value depends on condition. Shaded cells are unimplemented, read as '0'.
- Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for PC<15:8> whose contents are updated from or transferred to the upper byte of the program counter.
- 2: The \overline{TO} and \overline{PD} status bits in CPUSTA are not affected by a MCLR reset.
- 3: Other (non power-up) resets include: external reset through MCLR and the Watchdog Timer Reset.
- 4: The following values are for both TBLPTRL and TBLPTRH:
All PIC17C4X devices (Power-on Reset 0000 0000) and (All other resets 0000 0000)
except the PIC17C42 (Power-on Reset xxxx xxxx) and (All other resets uuuu uuuu)
- 5: The PRODL and PRODH registers are not implemented on the PIC17C42.

6.2.2.2 CPU STATUS REGISTER (CPUSTA)

The CPUSTA register contains the status and control bits for the CPU. This register is used to globally enable/disable interrupts. If only a specific interrupt is desired to be enabled/disabled, please refer to the INTerrupt Status (INTSTA) register and the Peripheral Interrupt Enable (PIE) register. This register also indicates if the stack is available and contains the Power-down (\overline{PD}) and Time-out (\overline{TO}) bits. The \overline{TO} , \overline{PD} , and STKAV bits are not writable. These bits are set and cleared according to device logic. Therefore, the result of an instruction with the CPUSTA register as destination may be different than intended.

FIGURE 6-8: CPUSTA REGISTER (ADDRESS: 06h, UNBANKED)

U - 0	U - 0	R - 1	R/W - 1	R - 1	R - 1	U - 0	U - 0
—	—	STKAV	GLINTD	\overline{TO}	\overline{PD}	—	—
bit7							bit0

R = Readable bit
W = Writable bit
U = Unimplemented bit, Read as '0'
- n = Value at POR reset

bit 7-6: **Unimplemented:** Read as '0'

bit 5: **STKAV:** Stack Available bit
This bit indicates that the 4-bit stack pointer value is Fh, or has rolled over from Fh → 0h (stack overflow).
1 = Stack is available
0 = Stack is full, or a stack overflow may have occurred (Once this bit has been cleared by a stack overflow, only a device reset will set this bit)

bit 4: **GLINTD:** Global Interrupt Disable bit
This bit disables all interrupts. When enabling interrupts, only the sources with their enable bits set can cause an interrupt.
1 = Disable all interrupts
0 = Enables all un-masked interrupts

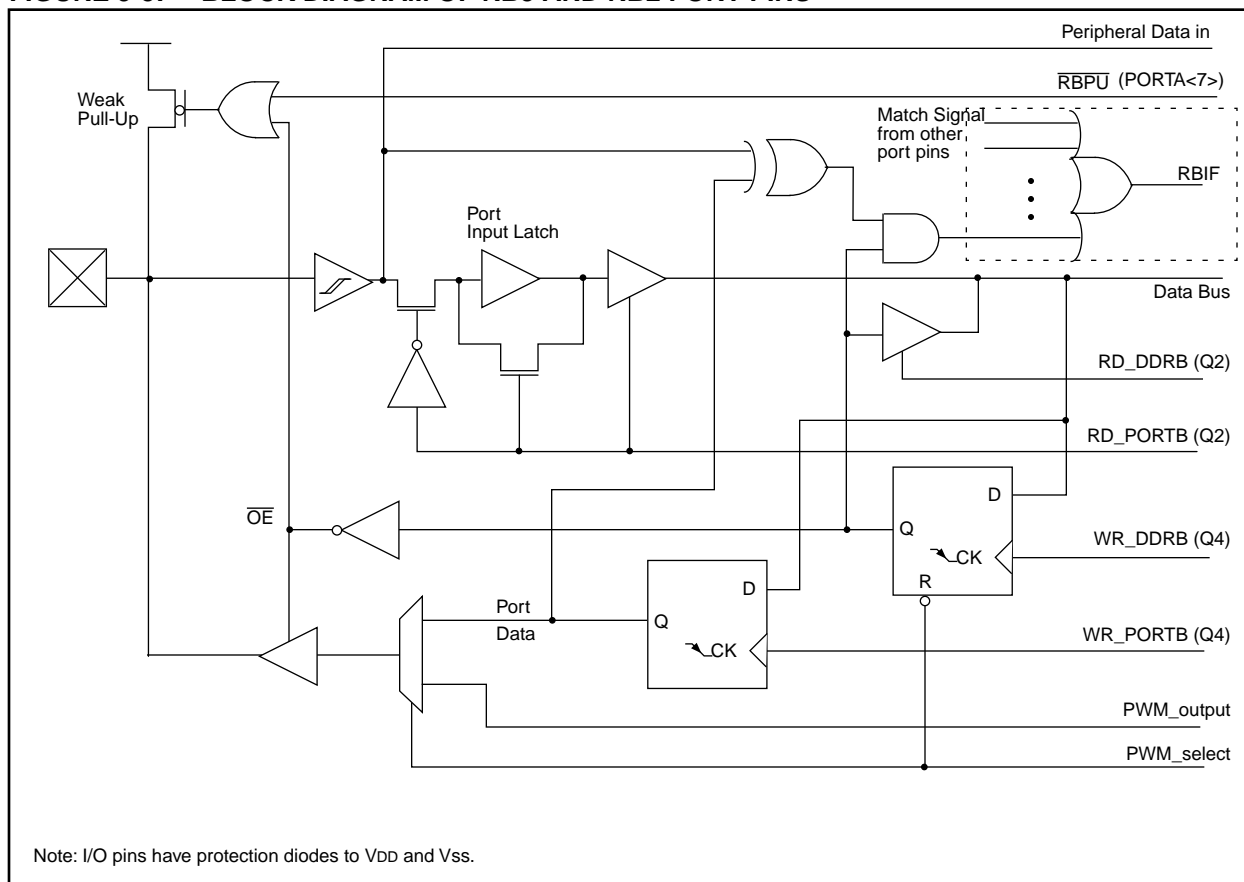
bit 3: **\overline{TO} :** WDT Time-out Status bit
1 = After power-up or by a CLRWD \overline{T} instruction
0 = A Watchdog Timer time-out occurred

bit 2: **\overline{PD} :** Power-down Status bit
1 = After power-up or by the CLRWD \overline{T} instruction
0 = By execution of the SLEEP instruction

bit 1-0: **Unimplemented:** Read as '0'

NOTES:

FIGURE 9-5: BLOCK DIAGRAM OF RB3 AND RB2 PORT PINS



PIC17C4X

Steps to follow when setting up an Asynchronous Reception:

1. Initialize the SPBRG register for the appropriate baud rate.
2. Enable the asynchronous serial port by clearing the SYNC bit and setting the SPEN bit.
3. If interrupts are desired, then set the RCIE bit.
4. If 9-bit reception is desired, then set the RX9 bit.
5. Enable the reception by setting the CREN bit.
6. The RCIF bit will be set when reception completes and an interrupt will be generated if the RCIE bit was set.

7. Read RCSTA to get the ninth bit (if enabled) and FERR bit to determine if any error occurred during reception.
8. Read RCREG for the 8-bit received data.
9. If an overrun error occurred, clear the error by clearing the OERR bit.

Note: To terminate a reception, either clear the SREN and CREN bits, or the SPEN bit. This will reset the receive logic, so that it will be in the proper state when receive is re-enabled.

FIGURE 13-8: ASYNCHRONOUS RECEPTION

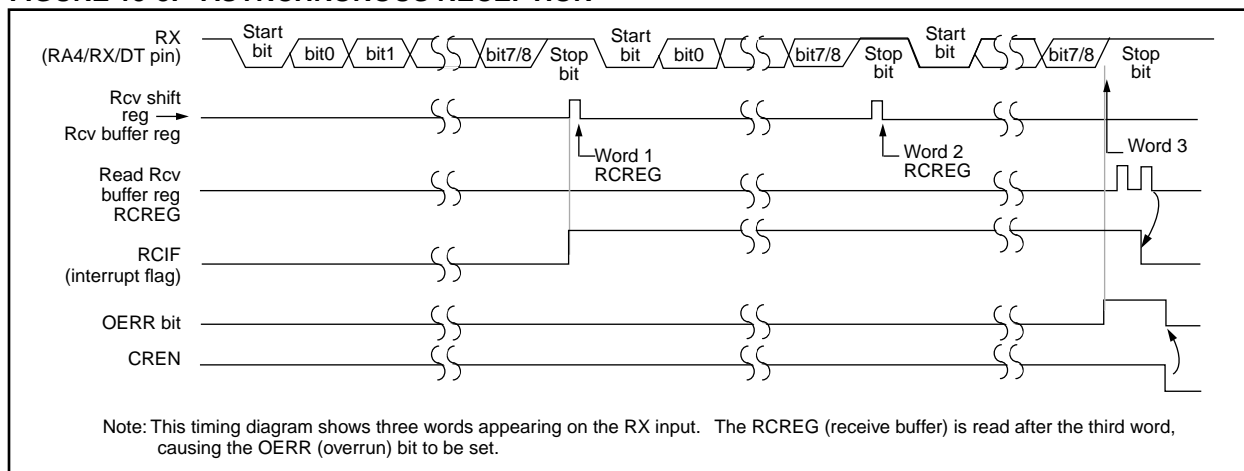


TABLE 13-6: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
16h, Bank 1	PIR	RBIF	TMR3IF	TMR2IF	TMR1IF	CA2IF	CA1IF	TXIF	RCIF	0000 0010	0000 0010
13h, Bank 0	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00u
14h, Bank 0	RCREG	RX7	RX6	RX5	RX4	RX3	RX2	RX1	RX0	xxxx xxxx	uuuu uuuu
17h, Bank 1	PIE	RBIE	TMR3IE	TMR2IE	TMR1IE	CA2IE	CA1IE	TXIE	RCIE	0000 0000	0000 0000
15h, Bank 0	TXSTA	CSRC	TX9	TXEN	SYNC	—	—	TRMT	TX9D	0000 --1x	0000 --1u
17h, Bank 0	SPBRG	Baud rate generator register								xxxx xxxx	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented read as a '0', shaded cells are not used for asynchronous reception.

Note 1: Other (non power-up) resets include: external reset through MCLR and Watchdog Timer Reset.

FIGURE 14-3: CRYSTAL OPERATION, OVERTONE CRYSTALS (XT OSC CONFIGURATION)

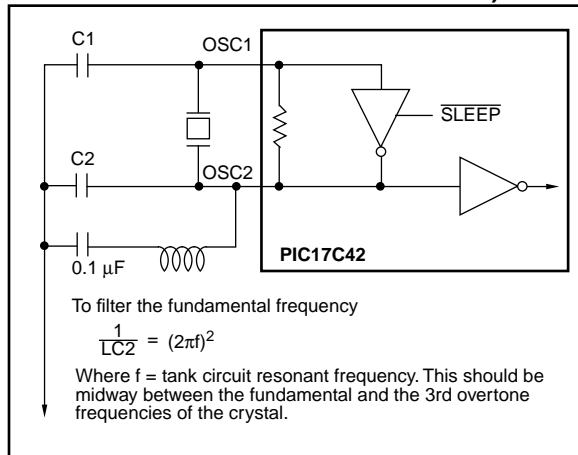


TABLE 14-2: CAPACITOR SELECTION FOR CERAMIC RESONATORS

Oscillator Type	Resonator Frequency	Capacitor Range C1 = C2
LF	455 kHz	15 - 68 pF
	2.0 MHz	10 - 33 pF
XT	4.0 MHz	22 - 68 pF
	8.0 MHz	33 - 100 pF
	16.0 MHz	33 - 100 pF

Higher capacitance increases the stability of the oscillator but also increases the start-up time. These values are for design guidance only. Since each resonator has its own characteristics, the user should consult the resonator manufacturer for appropriate values of external components.

Resonators Used:

455 kHz	Panasonic EFO-A455K04B	± 0.3%
2.0 MHz	Murata Erie CSA2.00MG	± 0.5%
4.0 MHz	Murata Erie CSA4.00MG	± 0.5%
8.0 MHz	Murata Erie CSA8.00MT	± 0.5%
16.0 MHz	Murata Erie CSA16.00MX	± 0.5%

Resonators used did not have built-in capacitors.

TABLE 14-3: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR

Osc Type	Freq	C1	C2
LF	32 kHz ⁽¹⁾	100-150 pF	100-150 pF
	1 MHz	10-33 pF	10-33 pF
	2 MHz	10-33 pF	10-33 pF
XT	2 MHz	47-100 pF	47-100 pF
	4 MHz	15-68 pF	15-68 pF
	8 MHz ⁽²⁾	15-47 pF	15-47 pF
	16 MHz	TBD	TBD
	25 MHz	15-47 pF	15-47 pF
	32 MHz ⁽³⁾	0 ⁽³⁾	0 ⁽³⁾

Higher capacitance increases the stability of the oscillator but also increases the start-up time and the oscillator current. These values are for design guidance only. Rs may be required in XT mode to avoid overdriving the crystals with low drive level specification. Since each crystal has its own characteristics, the user should consult the crystal manufacturer for appropriate values for external components.

Note 1: For VDD > 4.5V, C1 = C2 ≈ 30 pF is recommended.

2: Rs of 330Ω is required for a capacitor combination of 15/15 pF.

3: Only the capacitance of the board was present.

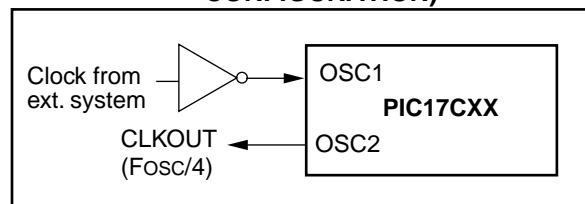
Crystals Used:

32.768 kHz	Epson C-001R32.768K-A	± 20 PPM
1.0 MHz	ECS-10-13-1	± 50 PPM
2.0 MHz	ECS-20-20-1	± 50 PPM
4.0 MHz	ECS-40-20-1	± 50 PPM
8.0 MHz	ECS ECS-80-S-4 ECS-80-18-1	± 50 PPM
16.0 MHz	ECS-160-20-1	TBD
25 MHz	CTS CTS25M	± 50 PPM
32 MHz	CRYSTEK HF-2	± 50 PPM

14.2.3 EXTERNAL CLOCK OSCILLATOR

In the EC oscillator mode, the OSC1 input can be driven by CMOS drivers. In this mode, the OSC1/CLKIN pin is hi-impedance and the OSC2/CLKOUT pin is the CLKOUT output (4 TOSC).

FIGURE 14-4: EXTERNAL CLOCK INPUT OPERATION (EC OSC CONFIGURATION)



BTFSS Bit Test, skip if Set

Syntax: [*label*] BTFSS *f*,*b*

Operands: $0 \leq f \leq 127$
 $0 \leq b < 7$

Operation: skip if (*f*<*b*>) = 1

Status Affected: None

Encoding:

1001	0bbb	ffff	ffff
------	------	------	------

Description: If bit 'b' in register 'f' is 1 then the next instruction is skipped.
 If bit 'b' is 1, then the next instruction fetched during the current instruction execution, is discarded and an NOP is executed instead, making this a two-cycle instruction.

Words: 1

Cycles: 1(2)

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	NOP

If skip:

Q1	Q2	Q3	Q4
Forced NOP	NOP	Execute	NOP

Example:

```

    HERE    BTFSS    FLAG,1
    FALSE   :
    TRUE    :
```

Before Instruction

PC = address (HERE)

After Instruction

```

    If FLAG<1> = 0;
    PC = address (FALSE)
    If FLAG<1> = 1;
    PC = address (TRUE)
```

BTG Bit Toggle f

Syntax: [*label*] BTG *f*,*b*

Operands: $0 \leq f \leq 255$
 $0 \leq b < 7$

Operation: ($\overline{f\langle b \rangle}$) → (*f*<*b*>)

Status Affected: None

Encoding:

0011	1bbb	ffff	ffff
------	------	------	------

Description: Bit 'b' in data memory location 'f' is inverted.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write register 'f'

Example: BTG PORTC, 4

Before Instruction:

PORTC = 0111 0101 [0x75]

After Instruction:

PORTC = 0110 0101 [0x65]

PIC17C4X

Applicable Devices 42 R42 42A 43 R43 44

17.2 DC CHARACTERISTICS: PIC17C42-16 (Commercial, Industrial) PIC17C42-25 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated)							
Operating temperature							
DC CHARACTERISTICS							
Operating voltage VDD range as described in Section 17.1							
Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
D030	VIL	Input Low Voltage					
D031		I/O ports					
D032		with TTL buffer	VSS	–	0.8	V	Note1
D033		with Schmitt Trigger buffer	VSS	–	0.2VDD	V	
D032		MCLR, OSC1 (in EC and RC mode)	VSS	–	0.2VDD	V	
D033		OSC1 (in XT, and LF mode)	–	0.5VDD	–	V	
D040	VIH	Input High Voltage					
D041		I/O ports					
D042		with TTL buffer	2.0	–	VDD	V	Note1
D043		with Schmitt Trigger buffer	0.8VDD	–	VDD	V	
D042		MCLR	0.8VDD	–	VDD	V	
D043		OSC1 (XT, and LF mode)	–	0.5VDD	–	V	
D050	VHYS	Hysteresis of Schmitt Trigger inputs	0.15VDD*	–	–	V	
D060	IIL	Input Leakage Current (Notes 2, 3)					
D060		I/O ports (except RA2, RA3)	–	–	±1	µA	VSS ≤ VPIN ≤ VDD, I/O Pin at hi-impedance PORTB weak pull-ups dis- abled
D061		MCLR	–	–	±2	µA	VPIN = VSS or VPIN = VDD
D062		RA2, RA3	–	–	±2	µA	VSS ≤ VRA2, VRA3 ≤ 12V
D063		OSC1, TEST	–	–	±1	µA	VSS ≤ VPIN ≤ VDD
D064		MCLR	–	–	10	µA	VMCLR = VPP = 12V (when not programming)
D070	IPURB	PORTB weak pull-up current	60	200	400	µA	VPIN = VSS, RBPU = 0

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

‡ These parameters are for design guidance only and are not tested, nor characterized.

†† Design guidance to attain the AC timing specifications. These loads are not tested.

Note 1: In RC oscillator configuration, the OSC1 pin is a Schmitt Trigger input. It is not recommended that the PIC17CXX devices be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as coming out of the pin.

4: These specifications are for the programming of the on-chip program memory EPROM through the use of the table write instructions. The complete programming specifications can be found in: PIC17CXX Programming Specifications (Literature number DS30139).

5: The MCLR/Vpp pin may be kept in this range at times other than programming, but this is not recommended.

6: For TTL buffers, the better of the two specifications may be used.

FIGURE 17-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP
TIMER TIMING

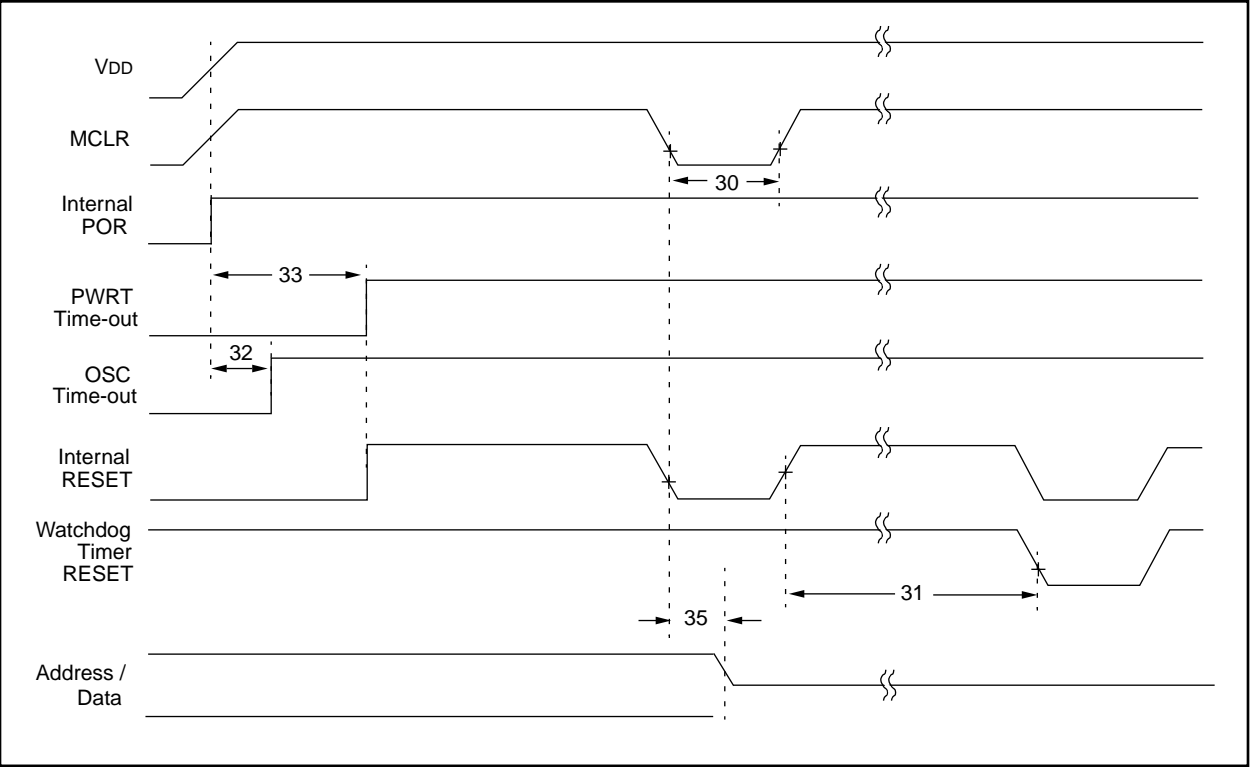


TABLE 17-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP
TIMER REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
30	Tmcl	MCLR Pulse Width (low)	100 *	—	—	ns	
31	Twdt	Watchdog Timer Time-out Period (Prescale = 1)	5 *	12	25 *	ms	
32	Tost	Oscillation Start-up Timer Period		1024 TOSC §		ms	TOSC = OSC1 period
33	Tpwrt	Power-up Timer Period	40 *	96	200 *	ms	
35	Tmcl2adl	MCLR to System Interface bus (AD15:AD0) invalid	—	—	100 *	ns	

* These parameters are characterized but not tested.
† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
‡ These parameters are for design guidance only and are not tested, nor characterized.
§ This specification ensured by design.

18.0 PIC17C42 DC AND AC CHARACTERISTICS

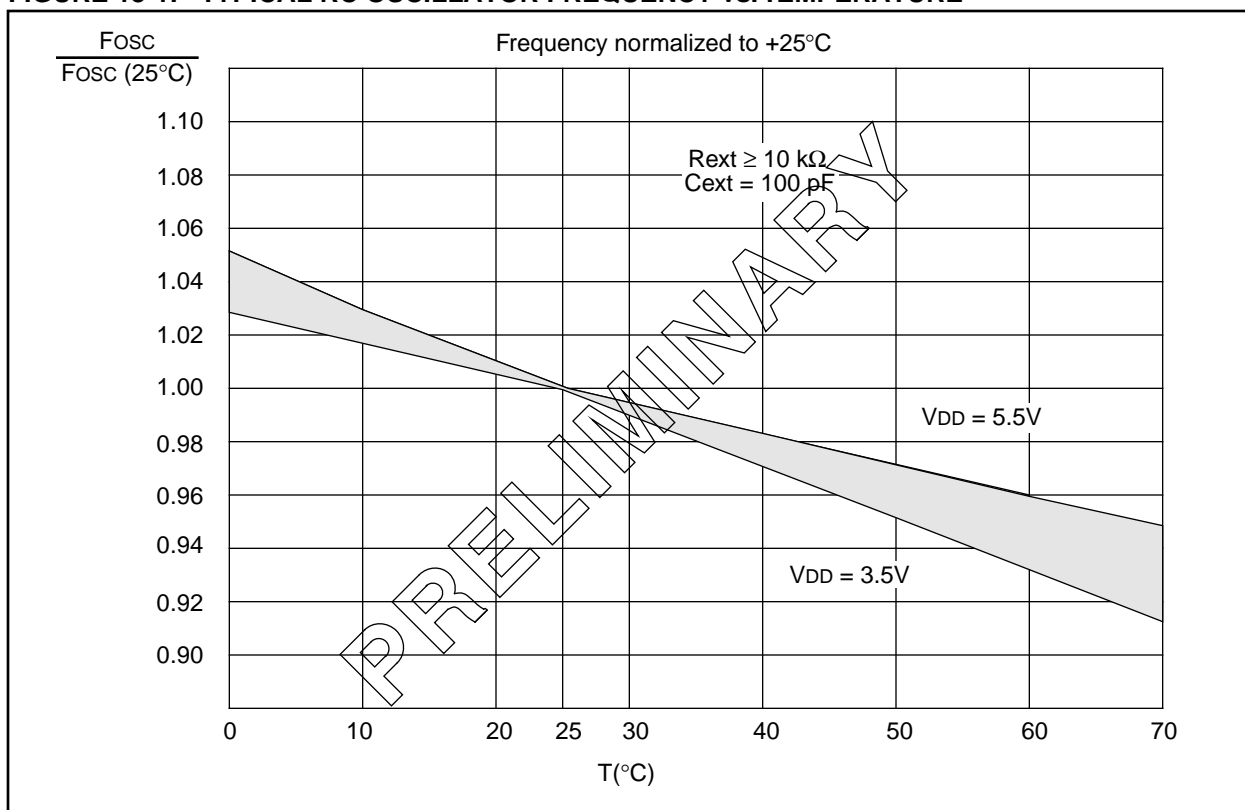
The graphs and tables provided in this section are for design guidance and are not tested or guaranteed. In some graphs or tables the data presented are outside specified operating range (e.g. outside specified V_{DD} range). This is for information only and devices are ensured to operate properly only within the specified range.

The data presented in this section is a statistical summary of data collected on units from different lots over a period of time. "Typical" represents the mean of the distribution while "max" or "min" represents $(\text{mean} + 3\sigma)$ and $(\text{mean} - 3\sigma)$ respectively where σ is standard deviation.

TABLE 18-1: PIN CAPACITANCE PER PACKAGE TYPE

Pin Name	Typical Capacitance (pF)			
	40-pin DIP	44-pin PLCC	44-pin MQFP	44-pin TQFP
All pins, except $\overline{\text{MCLR}}$, V_{DD} , and V_{SS}	10	10	10	10
$\overline{\text{MCLR}}$ pin	20	20	20	20

FIGURE 18-1: TYPICAL RC OSCILLATOR FREQUENCY vs. TEMPERATURE



PIC17C4X

Applicable Devices 42 R42 42A 43 R43 44

Standard Operating Conditions (unless otherwise stated)							
Operating temperature							
-40°C ≤ TA ≤ +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial							
Operating voltage VDD range as described in Section 19.1							
Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
D080	VOL	Output Low Voltage I/O ports (except RA2 and RA3)	—	—	0.1VDD	V	IOI = VDD/1.250 mA 4.5V ≤ VDD ≤ 6.0V
D081		with TTL buffer	—	—	0.1VDD *	V	VDD = 2.5V
D082		RA2 and RA3	—	—	0.4	V	IOI = 6 mA, VDD = 4.5V
D083		OSC2/CLKOUT	—	—	3.0	V	Note 6
D084		(RC and EC osc modes)	—	—	0.4	V	IOI = 60.0 mA, VDD = 6.0V
			—	—	0.1VDD *	V	IOI = 1 mA, VDD = 4.5V
			—	—	—	V	IOI = VDD/5 mA (PIC17LC43/LC44 only)
D090	VOH	Output High Voltage (Note 3) I/O ports (except RA2 and RA3)	—	—	—	V	IOH = -VDD/2.500 mA 4.5V ≤ VDD ≤ 6.0V
D091		with TTL buffer	0.9VDD	—	—	V	VDD = 2.5V
D092		RA2 and RA3	0.9VDD *	—	—	V	IOH = -6.0 mA, VDD = 4.5V
D093		OSC2/CLKOUT	2.4	—	—	V	Note 6
D094		(RC and EC osc modes)	0.9VDD *	—	—	V	Pulled-up to externally applied voltage
			—	—	—	V	IOH = -5 mA, VDD = 4.5V
			—	—	—	V	IOH = -VDD/5 mA (PIC17LC43/LC44 only)
D100	Cosc2	Capacitive Loading Specs on Output Pins OSC2/CLKOUT pin	—	—	25	pF	In EC or RC osc modes when OSC2 pin is outputting CLKOUT. external clock is used to drive OSC1.
D101	CIO	All I/O pins and OSC2 (in RC mode)	—	—	50	pF	
D102	CAD	System Interface Bus (PORTC, PORTD and PORTE)	—	—	50	pF	In Microprocessor or Extended Microcontroller mode

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

‡ These parameters are for design guidance only and are not tested, nor characterized.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC17CXX devices be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

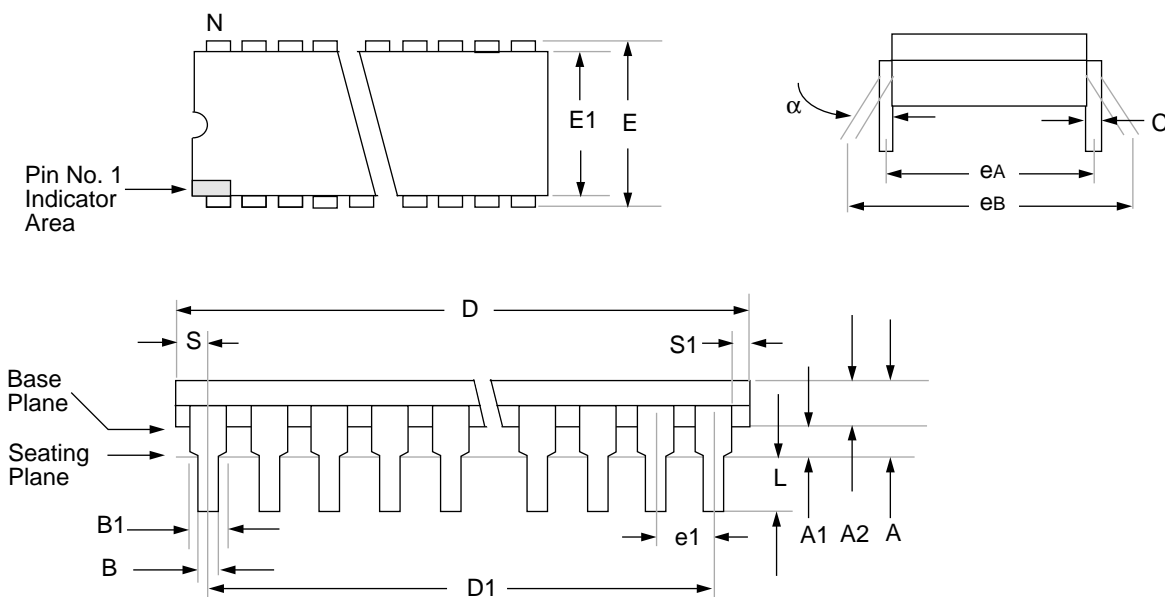
3: Negative current is defined as coming out of the pin.

4: These specifications are for the programming of the on-chip program memory EPROM through the use of the table write instructions. The complete programming specifications can be found in: PIC17CXX Programming Specifications (Literature number DS30139).

5: The MCLR/VPP pin may be kept in this range at times other than programming, but is not recommended.

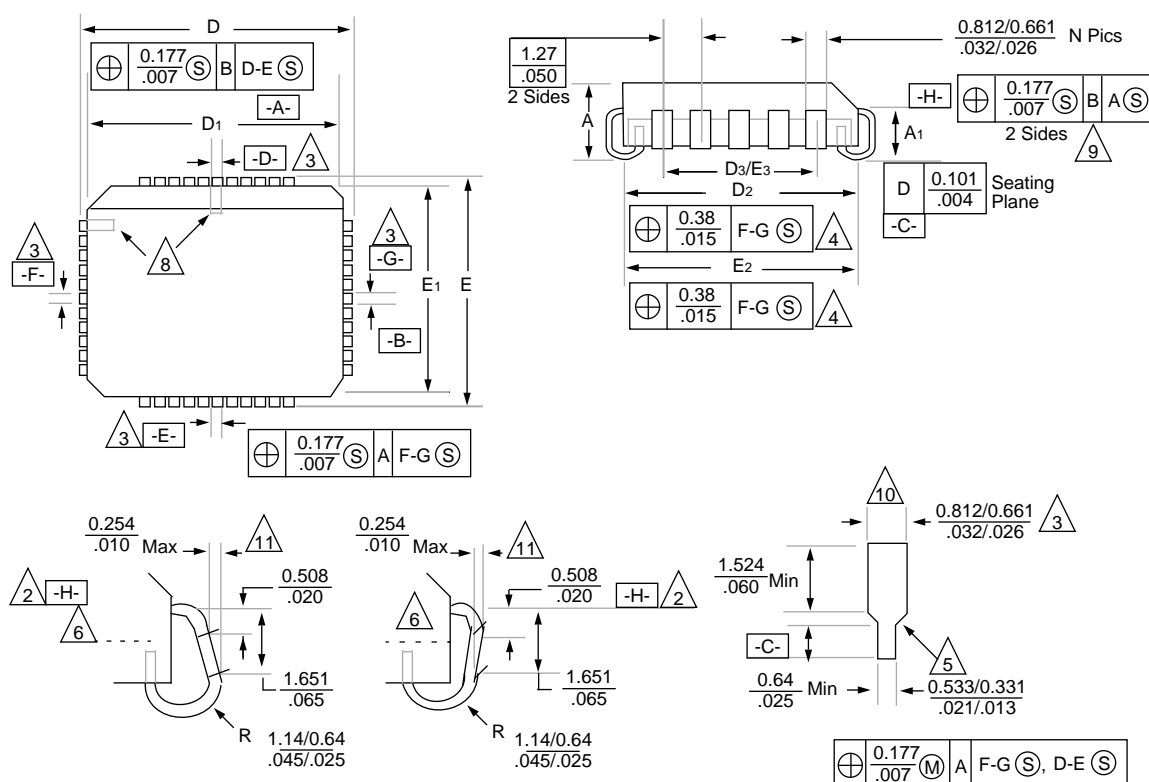
6: For TTL buffers, the better of the two specifications may be used.

21.2 40-Lead Plastic Dual In-line (600 mil)



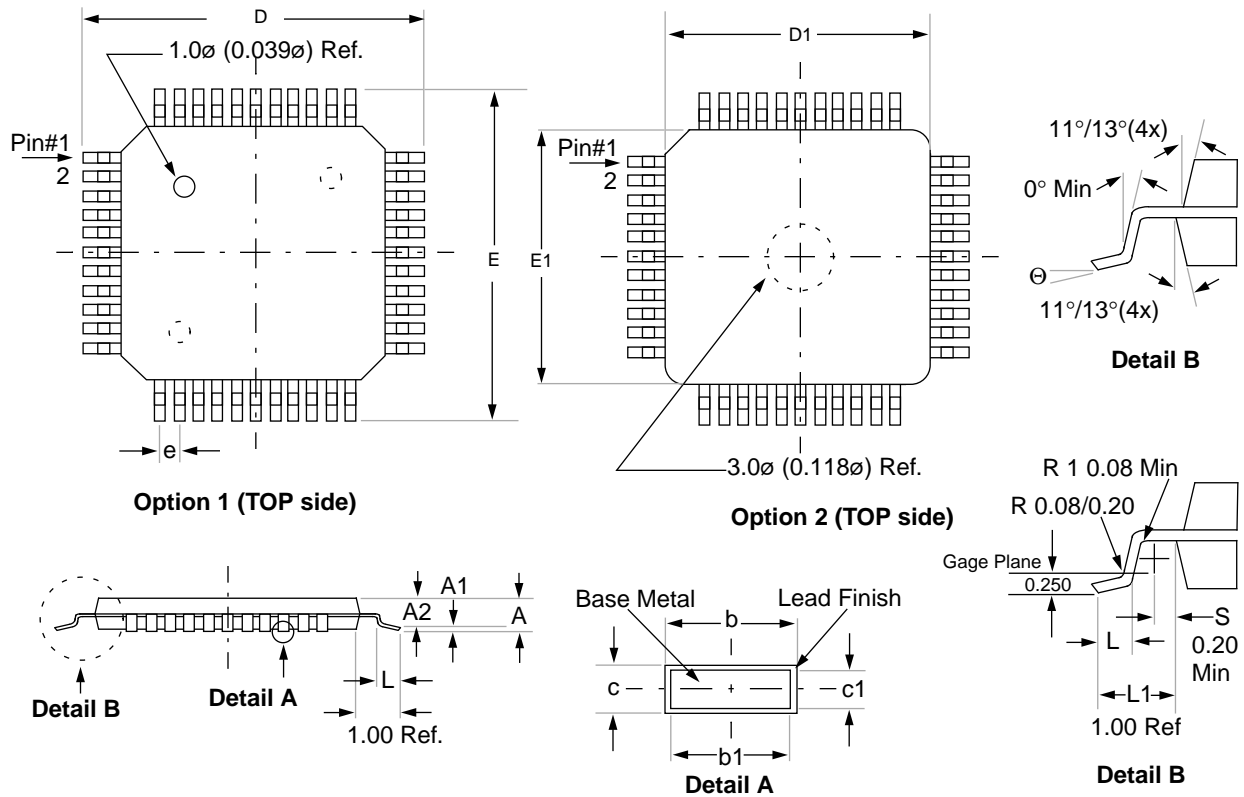
Package Group: Plastic Dual In-Line (PLA)						
Symbol	Millimeters			Inches		
	Min	Max	Notes	Min	Max	Notes
α	0°	10°		0°	10°	
A	—	5.080		—	0.200	
A1	0.381	—		0.015	—	
A2	3.175	4.064		0.125	0.160	
B	0.355	0.559		0.014	0.022	
B1	1.270	1.778	Typical	0.050	0.070	Typical
C	0.203	0.381	Typical	0.008	0.015	Typical
D	51.181	52.197		2.015	2.055	
D1	48.260	48.260	Reference	1.900	1.900	Reference
E	15.240	15.875		0.600	0.625	
E1	13.462	13.970		0.530	0.550	
e1	2.489	2.591	Typical	0.098	0.102	Typical
eA	15.240	15.240	Reference	0.600	0.600	Reference
eB	15.240	17.272		0.600	0.680	
L	2.921	3.683		0.115	0.145	
N	40	40		40	40	
S	1.270	—		0.050	—	
S1	0.508	—		0.020	—	

21.3 44-Lead Plastic Leaded Chip Carrier (Square)



Package Group: Plastic Leaded Chip Carrier (PLCC)						
Symbol	Millimeters			Inches		
	Min	Max	Notes	Min	Max	Notes
A	4.191	4.572		0.165	0.180	
A1	2.413	2.921		0.095	0.115	
D	17.399	17.653		0.685	0.695	
D1	16.510	16.663		0.650	0.656	
D2	15.494	16.002		0.610	0.630	
D3	12.700	12.700	Reference	0.500	0.500	Reference
E	17.399	17.653		0.685	0.695	
E1	16.510	16.663		0.650	0.656	
E2	15.494	16.002		0.610	0.630	
E3	12.700	12.700	Reference	0.500	0.500	Reference
N	44	44		44	44	
CP	—	0.102		—	0.004	
LT	0.203	0.381		0.008	0.015	

21.5 44-Lead Plastic Surface Mount (TQFP 10x10 mm Body 1.0/0.10 mm Lead Form)



Package Group: Plastic TQFP						
Symbol	Millimeters			Inches		
	Min	Max	Notes	Min	Max	Notes
A	1.00	1.20		0.039	0.047	
A1	0.05	0.15		0.002	0.006	
A2	0.95	1.05		0.037	0.041	
D	11.75	12.25		0.463	0.482	
D1	9.90	10.10		0.390	0.398	
E	11.75	12.25		0.463	0.482	
E1	9.90	10.10		0.390	0.398	
L	0.45	0.75		0.018	0.030	
e	0.80 BSC			0.031 BSC		
b	0.30	0.45		0.012	0.018	
b1	0.30	0.40		0.012	0.016	
c	0.09	0.20		0.004	0.008	
c1	0.09	0.16		0.004	0.006	
N	44	44		44	44	
Θ	0°	7°		0°	7°	

Note 1: Dimensions D1 and E1 do not include mold protrusion. Allowable mold protrusion is 0.25mm (0.010") per side. D1 and E1 dimensions including mold mismatch.

2: Dimension "b" does not include Dambar protrusion, allowable Dambar protrusion shall be 0.08mm (0.003") max.

3: This outline conforms to JEDEC MS-026.

E.5 PIC16C7X Family of Devices

	Clock		Memory		Peripherals					Features			
	Maximum Frequency of Operation (MHz)		EPROM Program Memory (Kx4 words)	Data Memory (bytes)	Timer Modules(s)	Capture/Compare/PWM Modules(s)	Serial Ports (SPI/I ² C, USART)	A/D Converter (8-bit) Channels	I/O Pins	Voltage Range (Volts)	In-Circuit Serial Programming	Brown-out Reset	Packages
PIC16C710	20	512	36	TMR0	—	—	—	4	4	13	3.0-6.0	Yes	18-pin DIP, SOIC; 20-pin SSOP
PIC16C71	20	1K	36	TMR0	—	—	—	4	4	13	3.0-6.0	Yes	18-pin DIP, SOIC
PIC16C711	20	1K	68	TMR0	—	—	—	4	4	13	3.0-6.0	Yes	18-pin DIP, SOIC; 20-pin SSOP
PIC16C72	20	2K	128	TMR0, TMR1, TMR2	1 SPI/I ² C	—	—	5	8	22	2.5-6.0	Yes	28-pin SDIP, SOIC, SSOP
PIC16C73	20	4K	192	TMR0, TMR1, TMR2	2 SPI/I ² C, USART	—	—	5	11	22	3.0-6.0	Yes	28-pin SDIP, SOIC
PIC16C73A ⁽¹⁾	20	4K	192	TMR0, TMR1, TMR2	2 SPI/I ² C, USART	—	—	5	11	22	2.5-6.0	Yes	28-pin SDIP, SOIC
PIC16C74	20	4K	192	TMR0, TMR1, TMR2	2 SPI/I ² C, USART	Yes	Yes	8	12	33	3.0-6.0	Yes	40-pin DIP; 44-pin PLCC, MQFP
PIC16C74A ⁽¹⁾	20	4K	192	TMR0, TMR1, TMR2	2 SPI/I ² C, USART	Yes	Yes	8	12	33	2.5-6.0	Yes	40-pin DIP; 44-pin PLCC, MQFP, TQFP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability.

All PIC16C7X Family devices use serial programming with clock pin RB6 and data pin RB7.

Note 1: Please contact your local sales office for availability of these devices.

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